

# Harvatek Surface Mount CHIP LEDs Data Sheet B1211NG--20C000134U1930

Official Product	HT Part No. B1211NG20C000134U1930				
Tentative Product	********				
Specifications are subject notice. Proprietary data, dr	10/12/2020	Version 1.8	Page 1/14		



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#### **DISCLAIMER**

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#### **Life Support Policy**

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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### **Product Specifications**

Item	Specification	Material	Quantity
Luminous	NG:112.5-450.0 mcd		
Intensity(Iv)	@20mA/ T <sub>s</sub> = 25°C ;Tolerance: <u>+</u> 10%		
Wavelength	NG:515-535 nm		
	@20mA/ $T_S$ = 25°C; Tolerance: $\pm$ 0.5nm		
Vf	NG:2.7-3.9V/0.2V/BIN		
	@20mA/ $T_S = 25^{\circ}C$ ; Tolerance: $\pm 0.05V$		
lr	< 10μA @ V <sub>R</sub> = 5 V		
Resin	Clear	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note: This is shipped test conditions

\*Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

#### ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

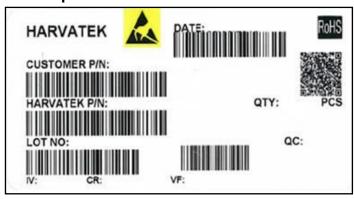
be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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# **Label Specifications**



Harvatek P/N:

B 121 1 NG-- 20C- 0001 34

Product	Package	Dice Qty	Color	Current	Series Number	Taping
B:PCB	1.6(L)x0.6(W)x1.0(H) mm	1:Single	Green	20mA	X001~XZZZ	1.Taping style
						2. Qty

## Lot No.:

1 2	3	4	5	6	7	8	9	10
E 1	Α	1	Α	2	2	L	1	2
Code 12	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	9
Internal Tracing Cod	2020-L 2021-M 2022-P 2023-Q  e 2026-T 2027-V  2030-Y 2031-Z	1:Jan. 2:Feb.  A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C  26:Z 27:7 28:8 29:9 30:3 31:4	01-	-ZZ		000-ZZZ	

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# **Specifications Range**

# ■Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range
	R	112.5-180.0 mcd
No	S	180.0-285.0 mcd
NG	Т	285.0-360.0 mcd
	U	360.0-450.0 mcd

Note: It maintains a tolerance of ±10% on Luminous Intensity

# **■**Wavelength Bin:

Color	Bin Code Spec. Range		
	Α	515.0-520.0 nm	
	В	520.0-525.0 nm	
NG	С	525.0-530.0 nm	
	D	530.0-535.0 nm	

Note: It maintains a tolerance of ±0.5nm on Wavelength Bin

# ■Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range		
	G8	2.7-2.9 V		
	H7	2.9-3.1 V		
NC	Н8	3.1-3.3 V		
NG	J7	3.3-3.5 V		
	J8	3.5-3.7 V		
	K7	3.7-3.9 V		

Note: It maintains a tolerance of ±0.05V on forward voltage measurements

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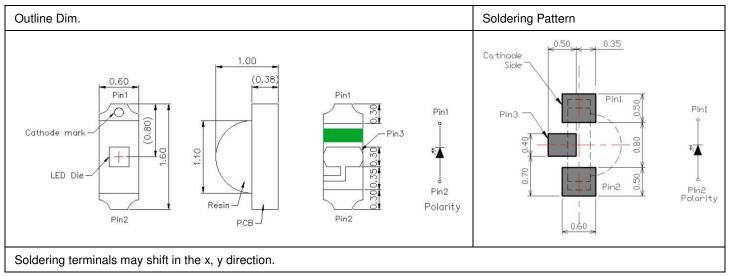
#### **Product Features**

# **Electro-Optical Characteristics**

								(I <sub>S</sub>	oldering , 25 °C)
Series	Emitting Color	Emitting Color Material -	V <sub>F</sub> (V)		Wavelength $\lambda$ (nm)		I <sub>V</sub> (mcd)	Viewing	
			typ	max	$\lambda_{D}$	$\lambda_{P}$	$\triangle \lambda$	Typical	Angle $2\theta \frac{1}{2}$
B1211NG20	NG	NG InGaN	3.3 3.9	3.9	525	520	30	285.0	X=135
	NG	ilidan 3.3		3.3	525	520	30	200.0	Y=120

# Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.25)



## **Absolute Maximum Ratings**

(T<sub>Soldering</sub> 25 °C)

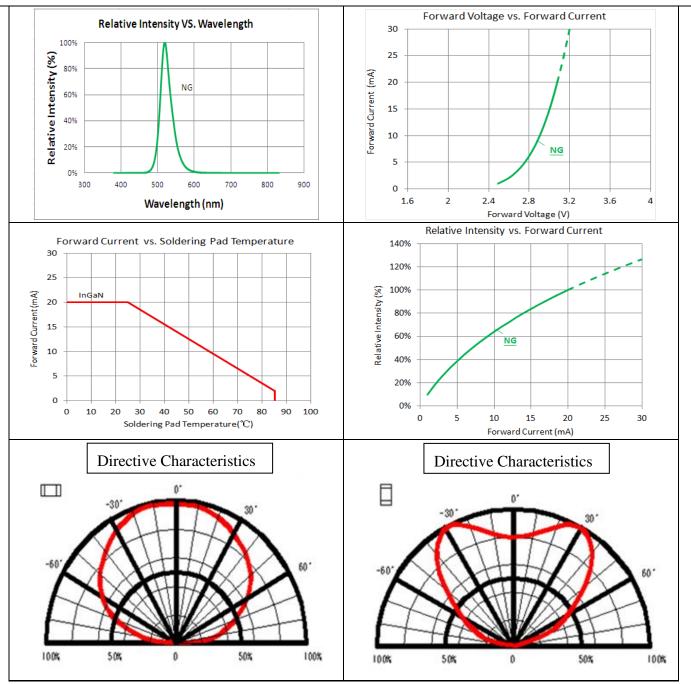
Series	P <sub>D</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)*	T <sub>OP</sub> (°C)	T <sub>ST</sub> (℃)
Color	Power		Forward Pulse Forward		Storage
Color	Dissipation	Current	Current	Temperature	Temperature
NG	78	20	80	-40~+85	-40~+100

<sup>\*</sup>Condition for I<sub>FP</sub> is pulse of 1/10 duty and 0.1 msec width

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# Characteristics of B1211NG



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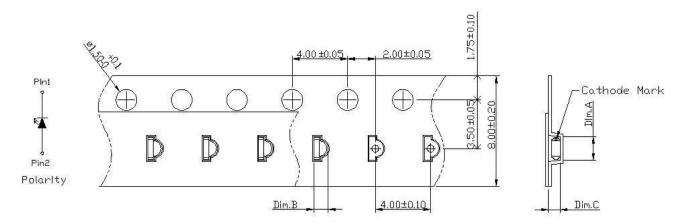
#### **Precaution for Use**

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

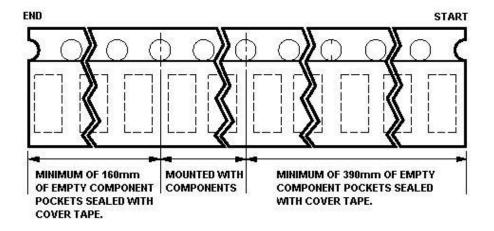
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# Packaging Tape Dimension



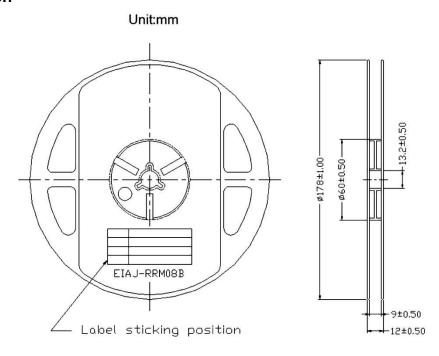
Dim. A	Dim. B	Dim. C	Qty/Reel
1.72+0.1-0.05	1.05+0.1-0.05	0.85±0.10	4K



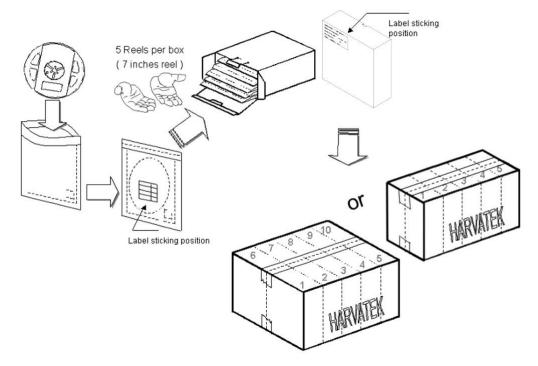
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# **Reel Dimension**



# **Packing**



5 or 10 boxes per carton is available depending on shipment quantity.

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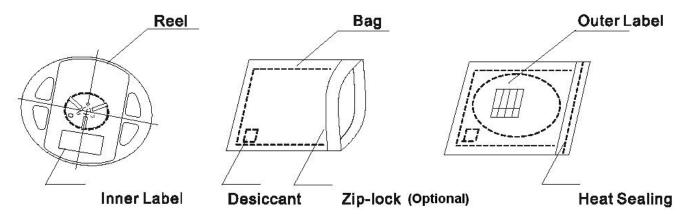


### **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



### **Baking**

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1.  $60\pm3^{\circ}$ C ×  $(12\sim24\text{hrs})$  and <5% RH, taped reel type.
- 2.  $100\pm3^{\circ}$ C × (45min~1hr), bulk type.
- 3.  $130\pm3^{\circ}$ C ×(15min~30min), bulk type.

#### **Precautions**

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

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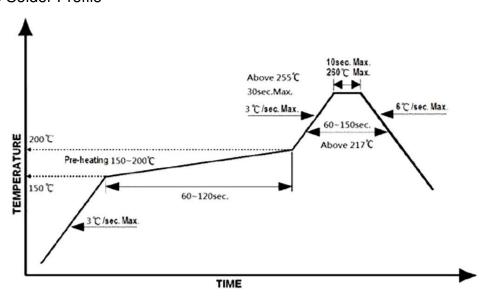


#### **Reflow Soldering**

Recommend soldering paste specifications:

- Operating temp.: Above 217<sup>°</sup>C ,60~150 sec
- 2. Peak temp.:260 <sup>O</sup>CMax.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

# Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter</li>
- Curing: 100 °C max, <3min</li>

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#### Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

## **Revise History**

Rev.	Descriptions	Date	Page
1.0	-	08/20/2013	-
1.1	Modify Max Forward Current	01/10/2014	P7
1.2	Renew Form	05/18/2015	-
1.3	Renew Form	12/22/2015	-
1.4	Renew Form	10/26/2016	-
1.5	Renew Form	08/18/2017	-
1.6	Renew Form	12/05/2017	-
1.7	Renew Form	07/23/2018	-
1.8	Add Customer Product Code	10/12/2020	P5

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